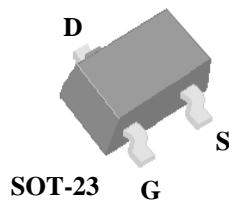
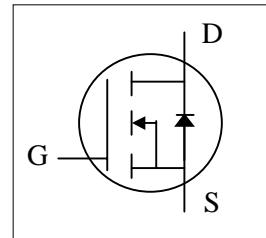




- ▼ Simple Drive Requirement
- ▼ Small Package Outline
- ▼ Surface Mount Device
- ▼ RoHS Compliant & Halogen-Free



BV_{DSS}	100V
$R_{DS(ON)}$	5Ω
I_D	0.25A



Description

Advanced Power MOSFETs utilized advanced processing techniques to achieve the lowest possible on-resistance, extremely efficient and cost-effectiveness device.

The SOT-23 package is widely used for commercial-industrial applications.

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current ³ , $V_{GS} @ 10V$	0.25	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current ³ , $V_{GS} @ 10V$	0.2	A
I_{DM}	Pulsed Drain Current ¹	1	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	0.7	W
	Linear Derating Factor	0.005	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient ³	180	°C/W



AP2320GN-HF

Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	100	-	-	V
$\text{R}_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=0.25\text{A}$	-	-	5	Ω
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=0.2\text{A}$	-	-	9	Ω
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	1	-	3	V
g_{fs}	Forward Transconductance	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=0.2\text{A}$	-	0.2	-	S
I_{DSS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=100\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	10	μA
I_{GSS}	Gate-Source Leakage	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Q_{g}	Total Gate Charge ²	$\text{I}_D=0.4\text{A}$	-	2	3.2	nC
Q_{gs}	Gate-Source Charge	$\text{V}_{\text{DS}}=80\text{V}$	-	0.5	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$\text{V}_{\text{GS}}=10\text{V}$	-	0.5	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time ²	$\text{V}_{\text{DS}}=50\text{V}$	-	3	-	ns
t_r	Rise Time	$\text{I}_D=0.4\text{A}$	-	7	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time	$\text{R}_G=3.3\Omega$	-	9.5	-	ns
t_f	Fall Time	$\text{V}_{\text{GS}}=10\text{V}$	-	4.5	-	ns
C_{iss}	Input Capacitance	$\text{V}_{\text{GS}}=0\text{V}$	-	32	51	pF
C_{oss}	Output Capacitance	$\text{V}_{\text{DS}}=25\text{V}$	-	9.5	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	6	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$\text{I}_S=0.4\text{A}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1.5	V
t_{rr}	Reverse Recovery Time	$\text{I}_S=1\text{A}, \text{V}_{\text{GS}}=0\text{V}, \frac{d\text{I}}{dt}=100\text{A}/\mu\text{s}$	-	27	-	ns
			-	28	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² copper pad of FR4 board ;400°C/W when mounted on min. copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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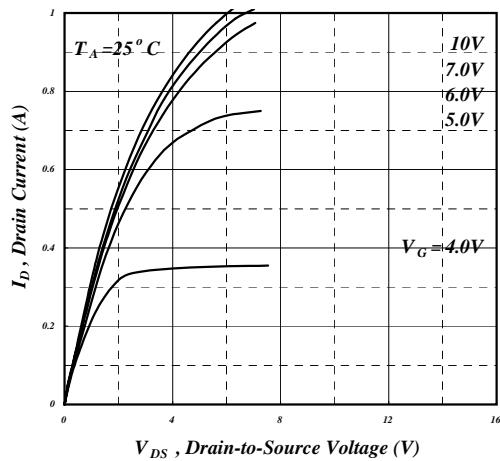


Fig 1. Typical Output Characteristics

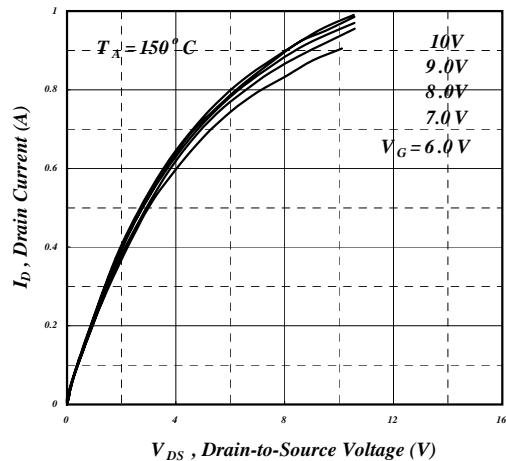


Fig 2. Typical Output Characteristics

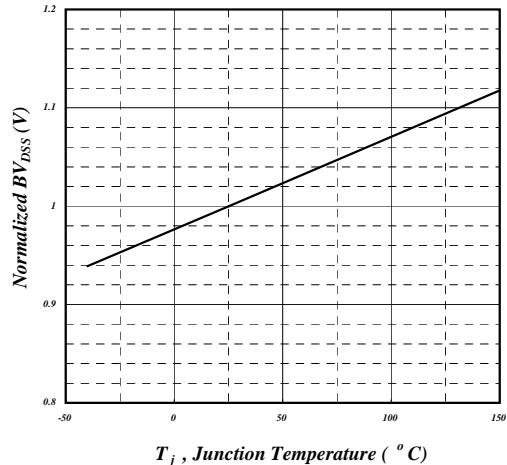
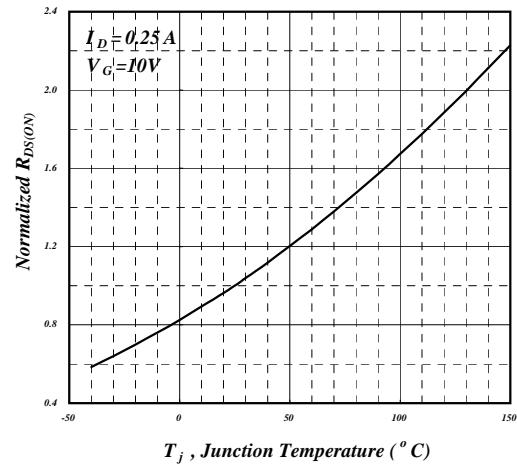
Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

Fig 4. Normalized On-Resistance v.s. Junction Temperature

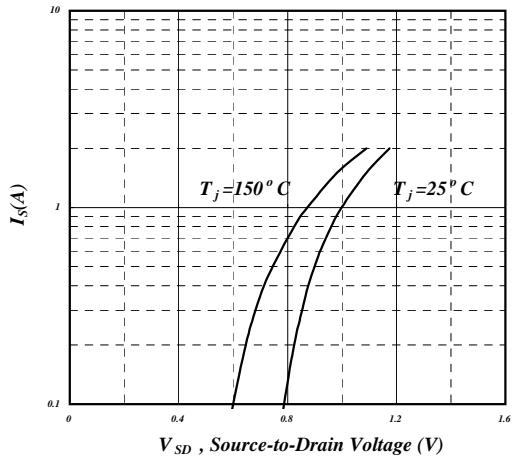


Fig 5. Forward Characteristic of Reverse Diode

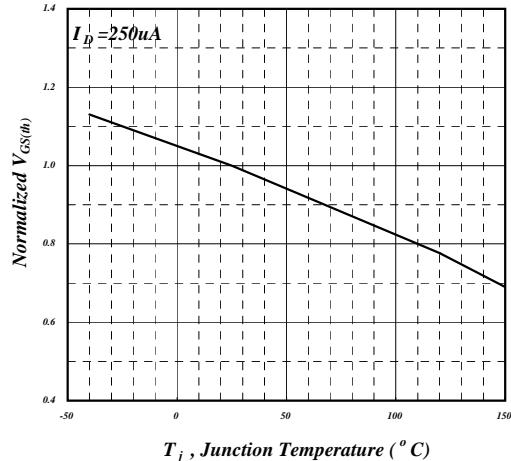


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

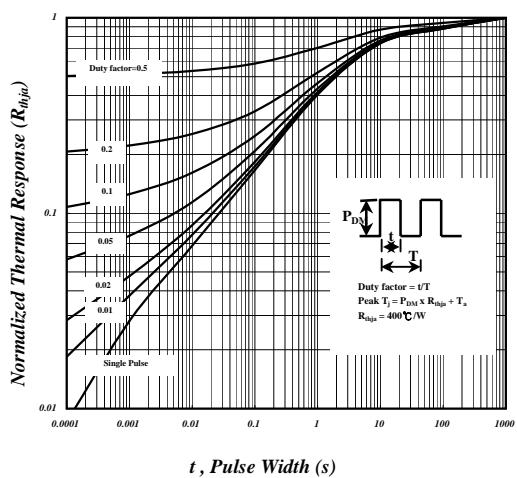
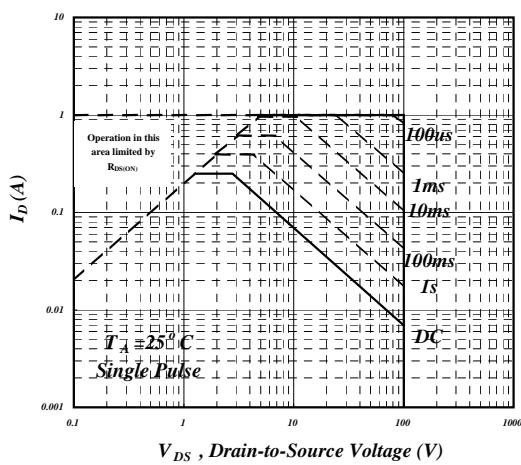
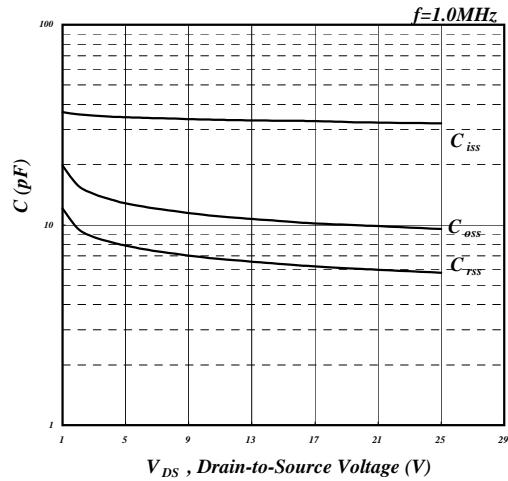
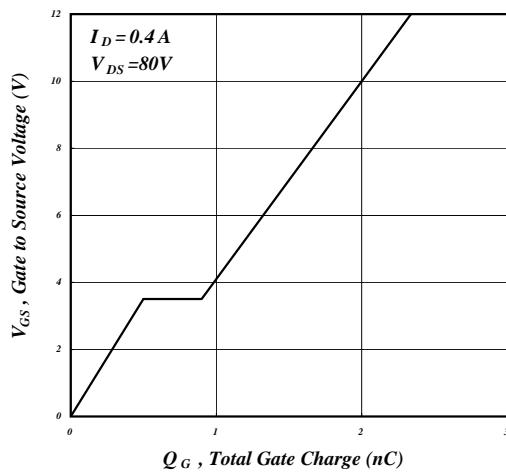


Fig 11. Switching Time Waveform

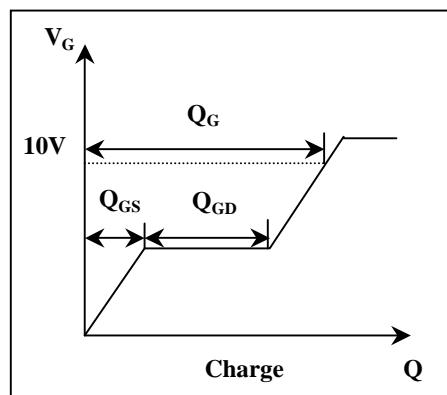
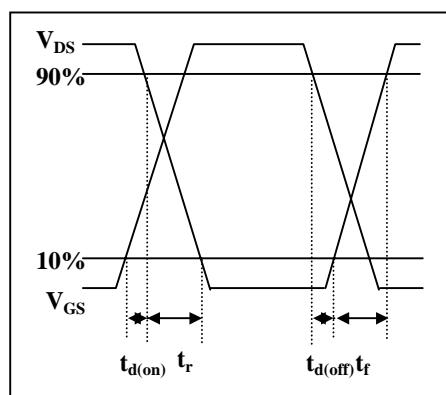


Fig 11. Switching Time Waveform

Fig 12. Gate Charge Waveform